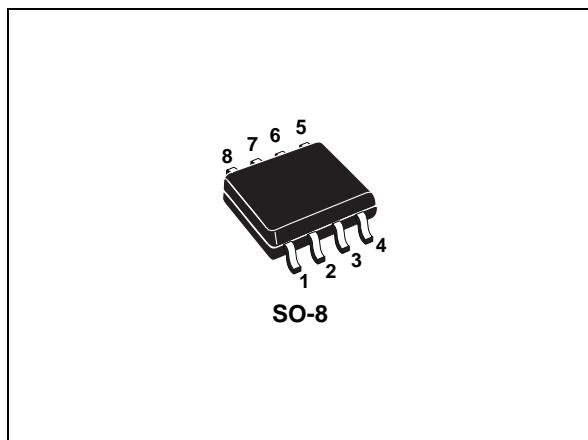


P-channel 60 V, 0.13 Ω typ., 3 A STripFET™ F6 Power MOSFET in a SO-8 package

Datasheet - production data



Features

Order code	V _{DSS}	R _{DS(on)max}	I _D
STN3P6F6	60 V	0.16 Ω @ 10 V	3 A

- R_{DS(on)} * Qg industry benchmark
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power losses

Applications

- Switching applications

Description

This device is a P-channel Power MOSFET developed using the 6th generation of STripFET™ technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest R_{DS(on)} in all packages.

Figure 1. Internal schematic diagram

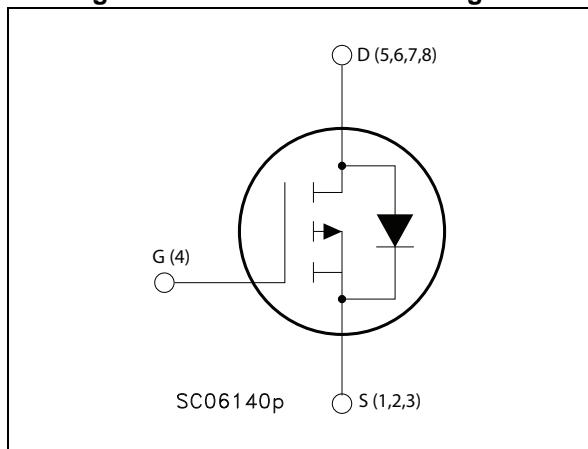


Table 1. Device summary

Order code	Marking	Package	Packaging
STS3P6F6	3K60	SO-8	Tape and reel

Note: For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.

Contents

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2.1	Electrical characteristics (curves)	6
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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	60	V
V_{GS}	Gate-source voltage	± 20	V
I_D	Drain current (continuous) at $T_{pcb} = 25^\circ\text{C}$	3	A
I_D	Drain current (continuous) at $T_{pcb} = 100^\circ\text{C}$	2	A
$I_{DM}^{(1)}$	Drain current (pulsed)	12	A
P_{TOT}	Total dissipation at $T_{pcb} = 25^\circ\text{C}$	2.7	W
T_j P_{stg}	Operating junction temperature Storage temperature	-55 to 150	$^\circ\text{C}$

1. Pulse width is limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb max	47	$^\circ\text{C}/\text{W}$

1. When mounted on FR-4 board of 15 mm^2 , 2 Oz Cu, $t < 10 \text{ sec}$

Note: For the P-channel Power MOSFET actual polarity of voltages and current has to be reversed.

2 Electrical characteristics

($T_{case} = 25^\circ C$ unless otherwise specified).

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0, I_D = 250 \mu A$	60			V
I_{DSS}	Zero gate voltage drain current	$V_{GS} = 0, V_{DS} = 60 V$			1	μA
		$V_{GS} = 0, V_{DS} = 60 V, T_C = 125^\circ C$			10	μA
I_{GSS}	Gate-body leakage current	$V_{DS} = 0, V_{GS} = \pm 20 V$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10 V, I_D = 1.5 A$		0.13	0.16	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{GS} = 0, V_{DS} = 48 V, f = 1 MHz$	-	340	-	pF
C_{oss}	Output capacitance		-	40	-	pF
C_{rss}	Reverse transfer capacitance		-	20	-	pF
Q_g	Total gate charge	$V_{DD} = 48 V, I_D = 3 A, V_{GS} = 10 V$ (see Figure 14)	-	6.4	-	nC
Q_{gs}	Gate-source charge		-	1.7	-	nC
Q_{gd}	Gate-drain charge		-	1.7	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 48 V, I_D = 1.5 A, R_G = 4.7 \Omega, V_{GS} = 10 V$ (see Figure 13)	-	64	-	ns
t_r	Rise time		-	5.3	-	ns
$t_{d(off)}$	Turn-off delay time		-	14	-	ns
t_f	Fall time		-	3.7	-	ns

Note: For the P-channel Power MOSFET actual polarity of voltages and current has to be reversed.

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		3	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		12	A
$V_{SD}^{(2)}$	Forward on voltage	$V_{GS} = 0, I_{SD} = 3 \text{ A}$	-		1.1	V
t_{rr}	Reverse recovery time	$I_{SD} = 5 \text{ A}, di/dt = 100 \text{ A}/\mu\text{s}$ $V_{DD} = 16 \text{ V}, T_j = 150 \text{ }^\circ\text{C}$ (see Figure 15)	-	20		ns
Q_{rr}	Reverse recovery charge		-	17.8		nC
I_{RRM}	Reverse recovery current		-	1.8		A

1. Pulse width limited by safe operating area.
2. Pulse duration = 300 μs , duty cycle 1.5%

Note: *For the P-channel Power MOSFET actual polarity of voltages and current has to be reversed.*

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

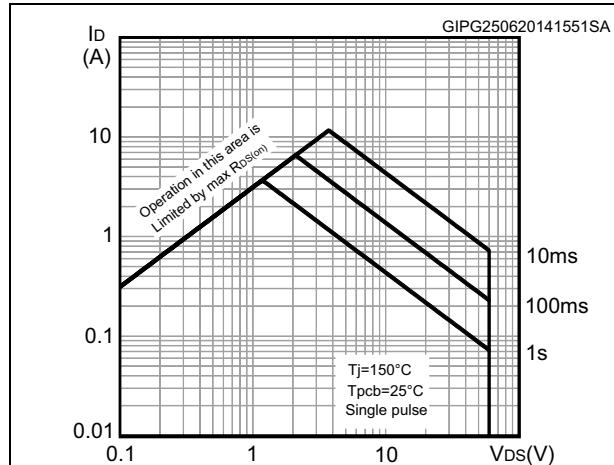


Figure 3. Thermal impedance

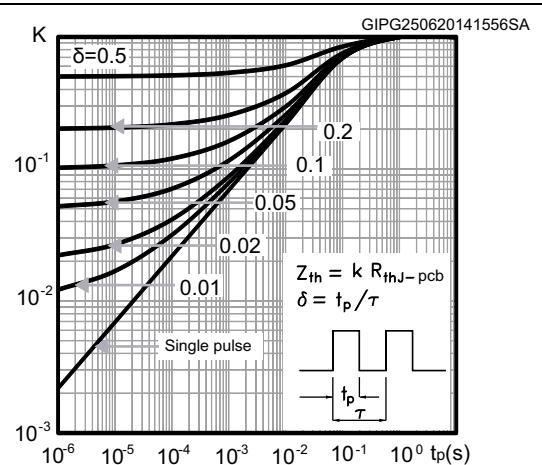


Figure 4. Output characteristics

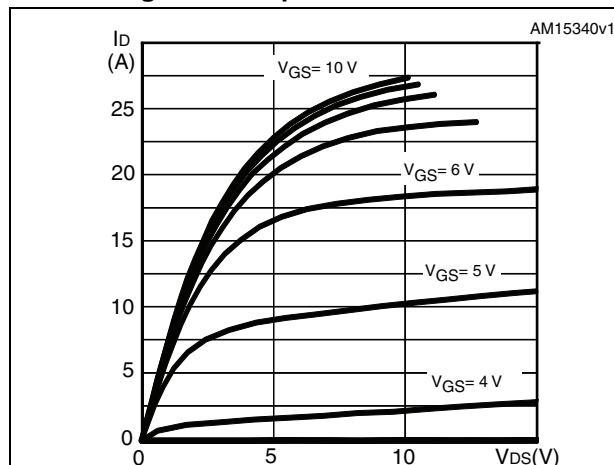


Figure 5. Transfer characteristics

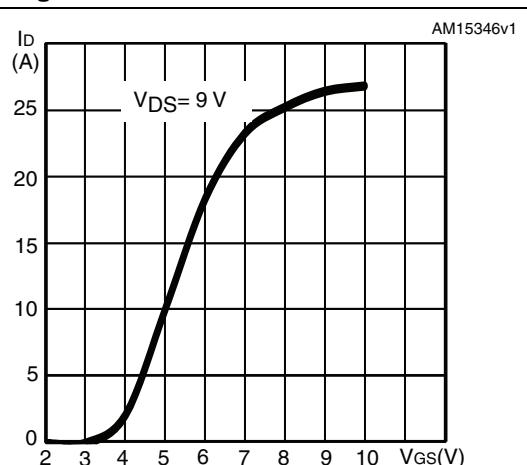


Figure 6. Gate charge vs gate-source voltage

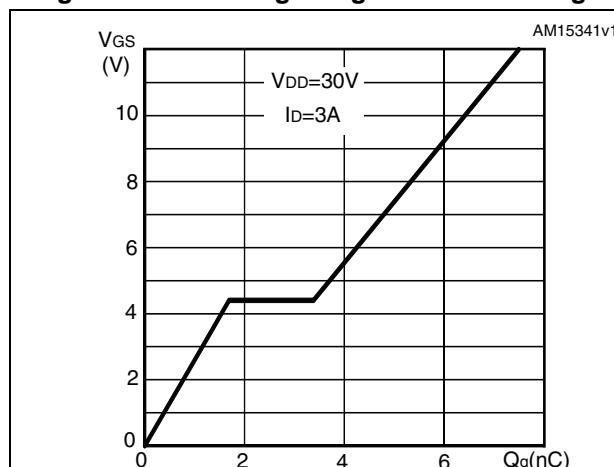


Figure 7. Static drain-source on-resistance

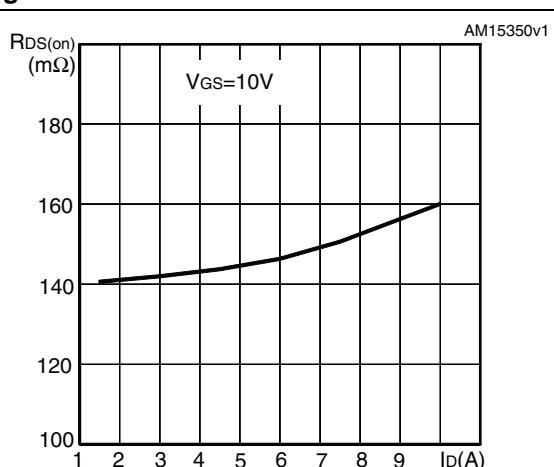
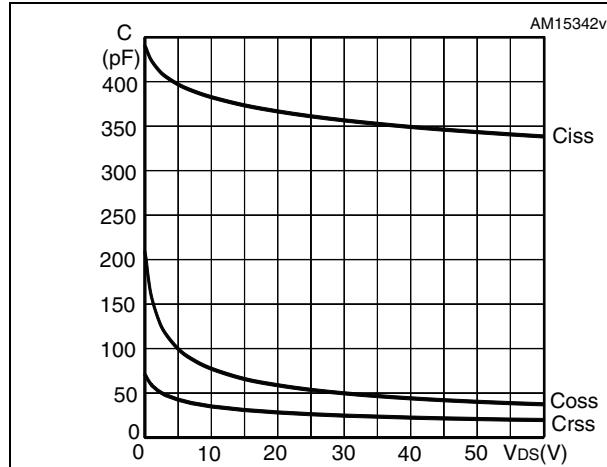
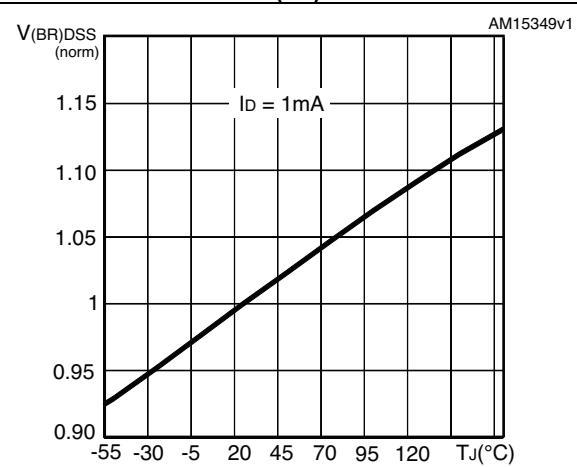
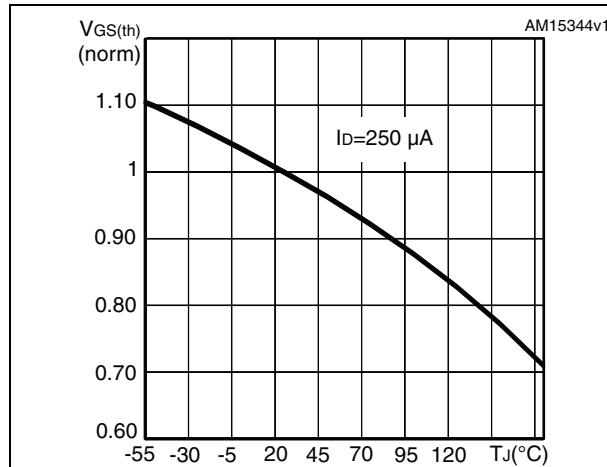
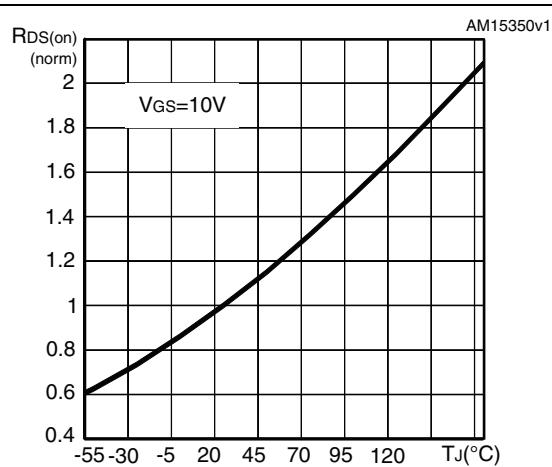
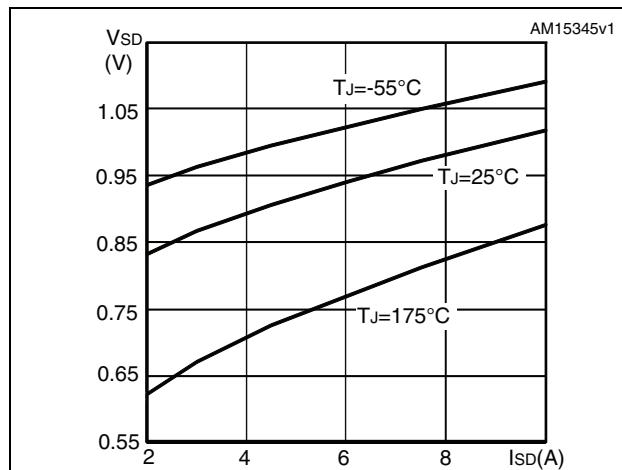


Figure 8. Capacitance variations**Figure 9. Normalized V_{(BR)DSS} vs temperature****Figure 10. Normalized gate threshold voltage vs temperature****Figure 11. Normalized on-resistance vs temperature****Figure 12. Source-drain diode forward characteristics**

3 Test circuits

Figure 13. Switching times test circuit for resistive load

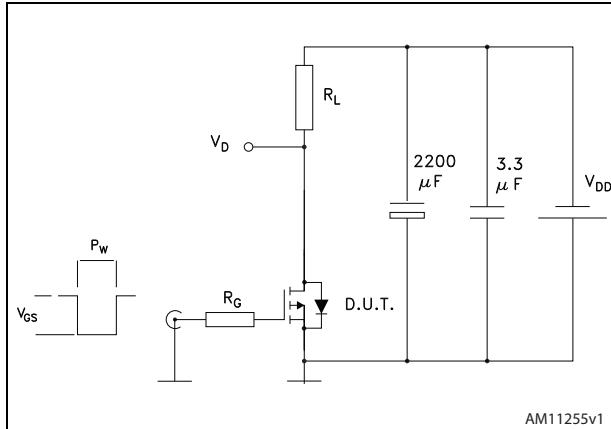


Figure 14. Gate charge test circuit

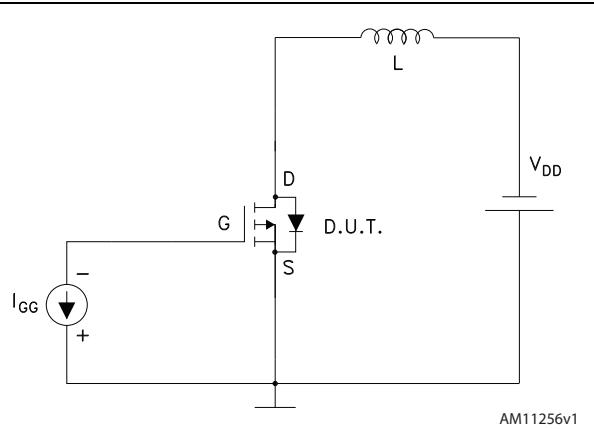
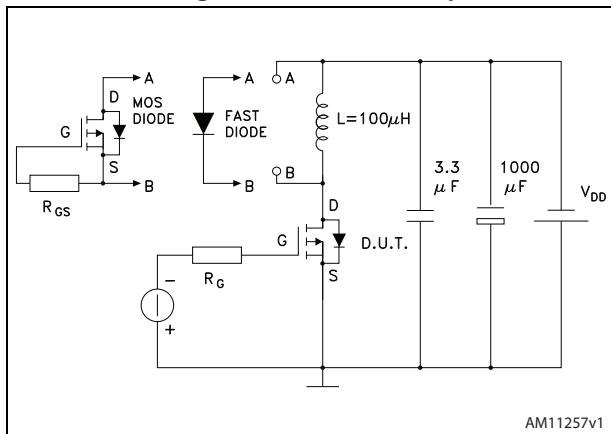


Figure 15. Test circuit for inductive load switching and diode recovery times



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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Figure 16. SO-8 drawing

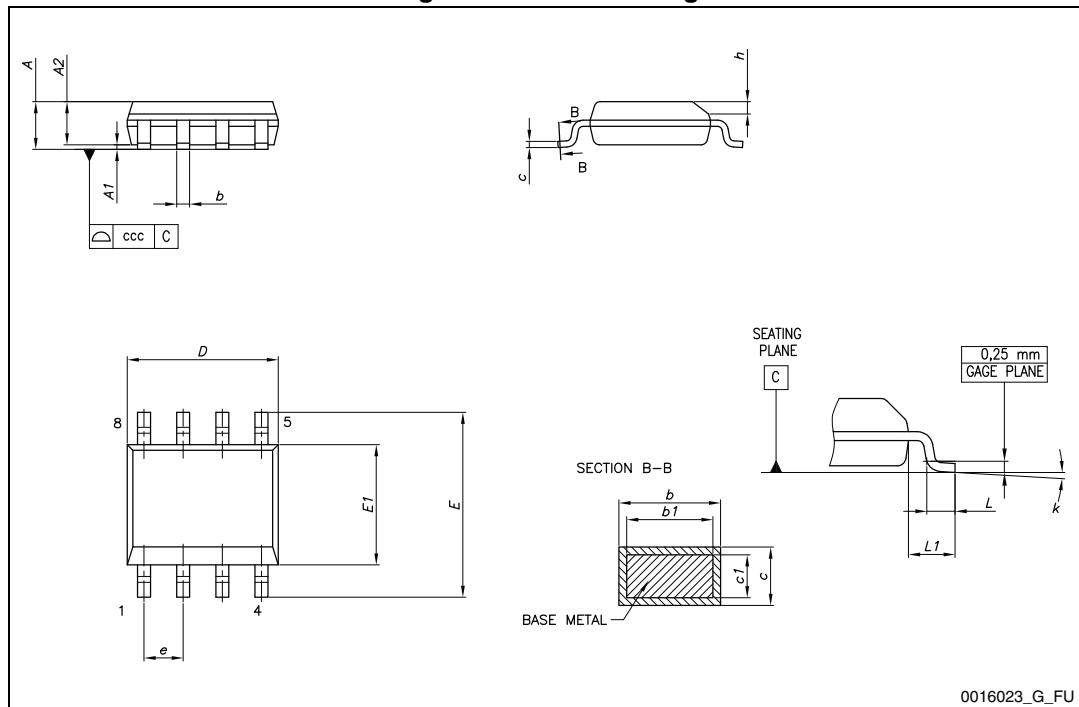
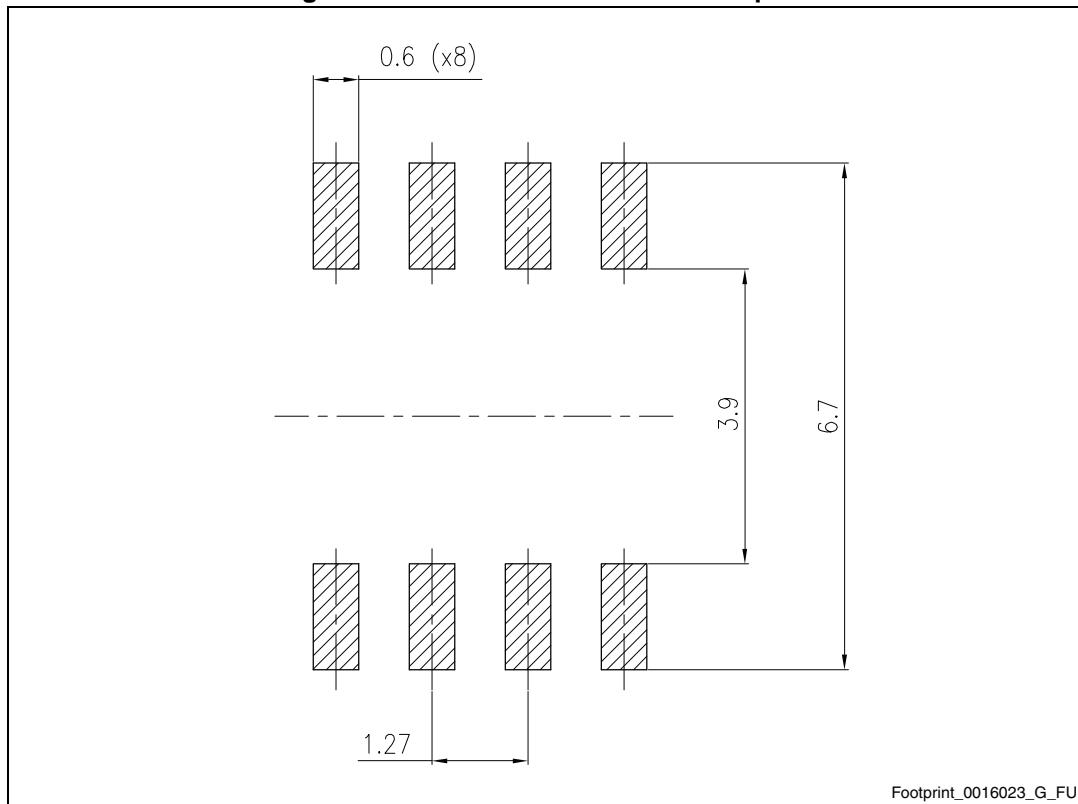


Table 8. SO-8 mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
c	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
k	0°		8°
ccc			0.10

Figure 17. (a) SO-8 recommended footprint

a. All dimensions are in millimeters.

5 Packaging mechanical data

Figure 18. SO-8 tape and reel dimensions

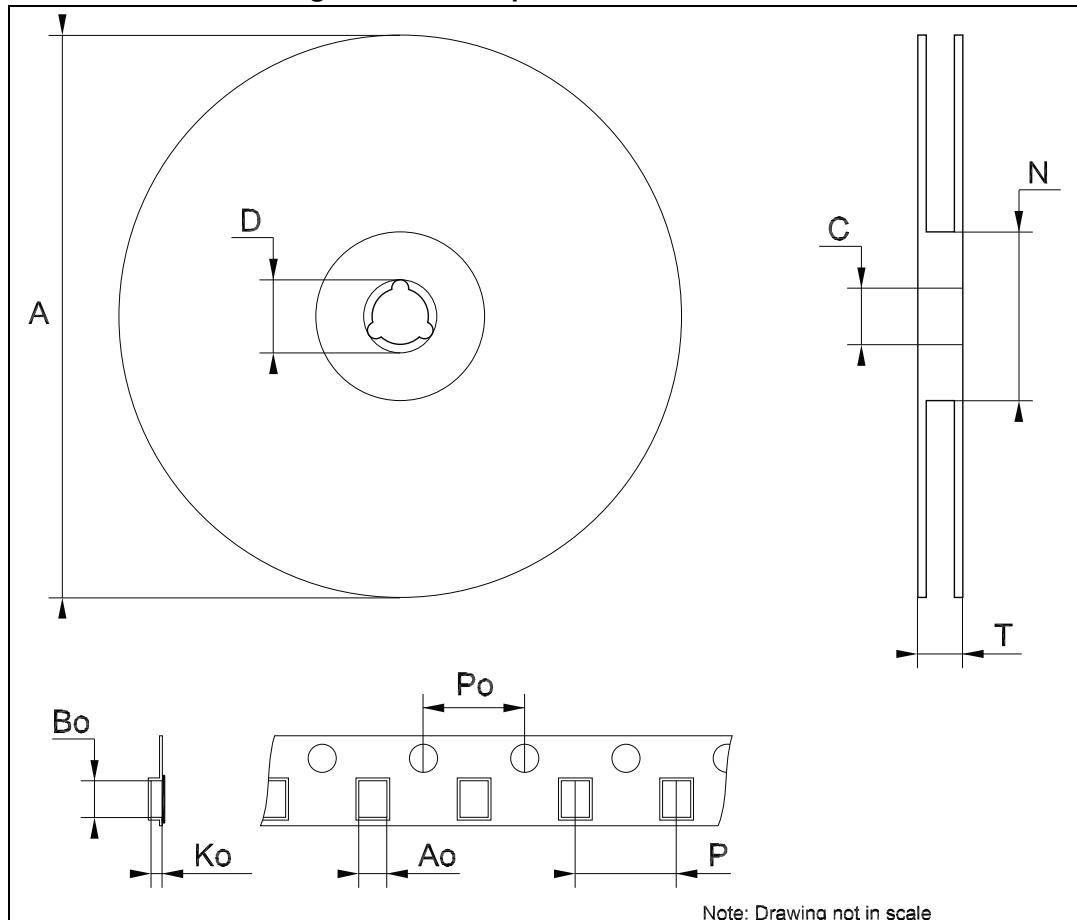


Table 9. SO-8 tape and reel mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A		-	330
C	12.8	-	13.2
D	20.2	-	
N	60	-	
T		-	22.4
Ao	8.1	-	8.5
Bo	5.5	-	5.9
Ko	2.1	-	2.3
Po	3.9	-	4.1
P	7.9	-	8.1

6 Revision history

Table 10. Document revision history

Date	Revision	Changes
22-Mar-2013	1	First release.
14-Jul-2014	2	<ul style="list-style-type: none">– Modified: the entire typical values in <i>Table 6</i>– Modified: <i>Section 3: Test circuits</i>– Added: <i>Section 2.1: Electrical characteristics (curves)</i>– Minor text changes

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